

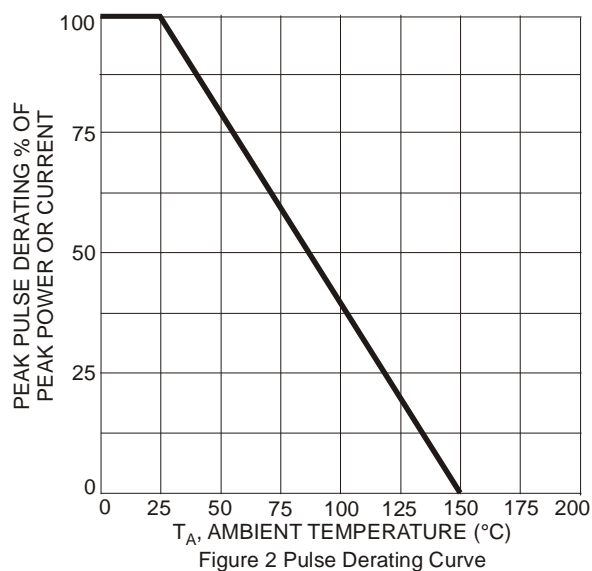
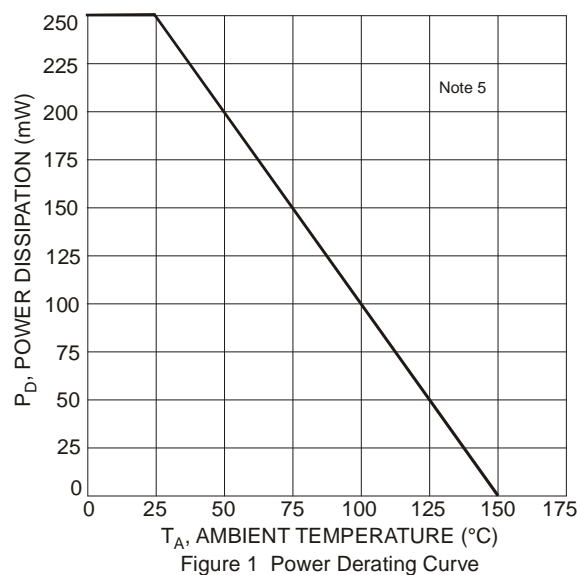
## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	$P_D$	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	500	$^{\circ}\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	$^{\circ}\text{C}$

## Electrical Characteristics (@ $T_A = +25^{\circ}\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	$V_{RWM}$	—	—	3.3	V	—
Channel Leakage Current (Note 6)	$I_{RM}$	—	—	2.0	$\mu\text{A}$	$V_{RWM} = 3.3\text{V}$
Clamping Voltage, IEC 61000-4-5	$V_{CL}$	—	—	8	V	$I_{PP} = 1\text{A}$ , $t_p = 8/20\mu\text{S}$
		—	—	10		$I_{PP} = 12\text{A}$ , $t_p = 8/20\mu\text{S}$
Breakdown Voltage	$V_{BR}$	5.0	—	—	V	$I_R = 1\text{mA}$
Channel Input Capacitance	$C_T$	—	70	80	pF	$V_R = 0\text{V}$ , $f = 1\text{MHz}$

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
  - Short duration pulse test used to minimize self-heating effect.



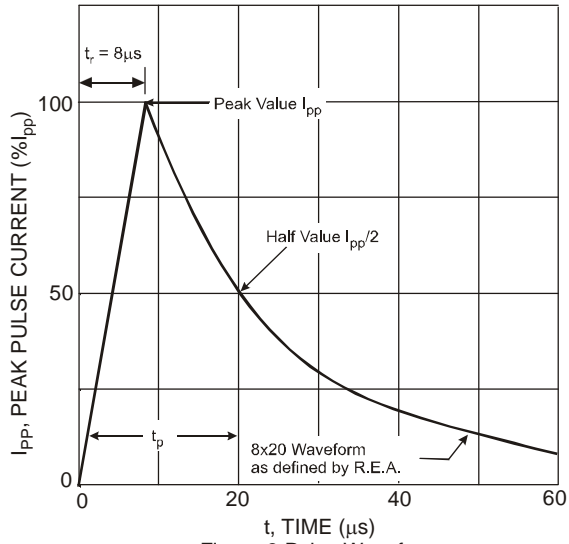


Figure 3 Pulse Waveform

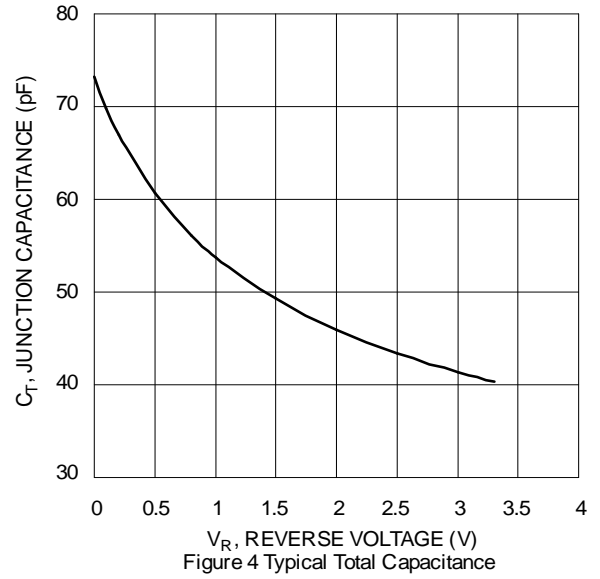
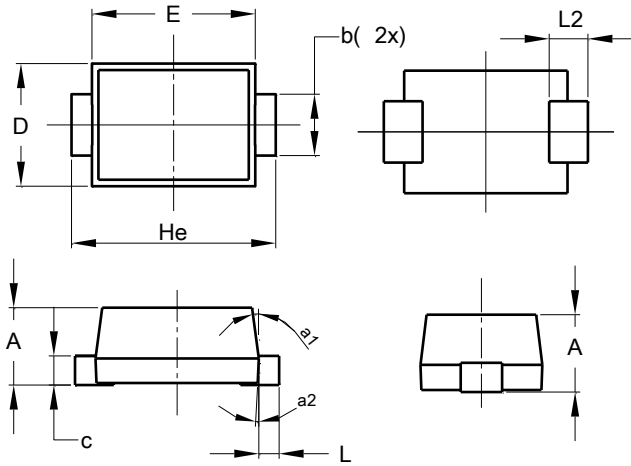


Figure 4 Typical Total Capacitance

## Package Outline Dimensions

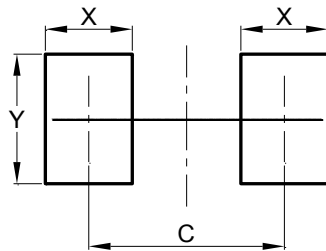
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOD923 (0.3mm Lead Width)			
Dim	Min	Max	Typ
A	0.34	0.40	0.37
b	0.25	0.35	0.30
c	0.05	0.15	0.10
D	0.55	0.65	0.60
E	0.75	0.85	0.80
He	0.95	1.05	1.00
L	0.05	0.15	0.10
L2	0.190 REF		
a1	0°	8°	7°
a2	2°	4°	3°
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.



Dimensions	Value (in mm)
C	0.900
X	0.400
Y	0.600

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